

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SOONOK JEON	09/10/2018
HIROSHI MIYAZAKI	09/10/2018
YEONSOOK CHUNG	09/10/2018
KYUNGDOC KIM	09/10/2018
YOUNGMIN NAM	09/10/2018
MYUNGSUN SIM	09/10/2018
HASUP LEE	09/10/2018
SOOGHANG IHN	09/10/2018
YASUSHI KOISHIKAWA	09/10/2018
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16166800
CORRESPONDENCE DATA	
Fax Number:	(860)286-0115
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	8602862929
Email:	usptopatentmail@cantorcolburn.com
Correspondent Name:	CANTOR COLBURN LLP
Address Line 1:	20 CHURCH STREET
Address Line 2:	22ND FLOOR
Address Line 4:	HARTFORD, CONNECTICUT 06103
ATTORNEY DOCKET NUMBER:	YPL2109US
NAME OF SUBMITTER:	IAN M. WASSER, PH.D.

PATENT

SIGNATURE:	/lan M. Wasser/
DATE SIGNED:	05/21/2021
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 3 source=8619914#page1.tif source=8619914#page2.tif source=8619914#page3.tif	

YPL2109US
RE-201706-004-1-US0
SI-54704-US

DECLARATION AND ASSIGNMENT

Title of Invention: **CONDENSED CYCLIC COMPOUND AND ORGANIC LIGHT-EMITTING DEVICE INCLUDING THE SAME**

As a below named inventor, I hereby declare that:

This declaration is directed to:

☒ the attached application (Attorney Docket Number YPL2109US) or

☐ United States application or PCT international application number
_____ filed on _____.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR Section 1.56.

Whereas, each undersigned inventor has made certain inventions, improvements, and discoveries (herein referred to as the "INVENTION") disclosed in the above-identified patent application (herein referred to as the ("APPLICATION");

Whereas, **Samsung Electronics Co., Ltd.**, a corporation of Country of Korea having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea (herein referred to as "ASSIGNEE"), desires to acquire, and each undersigned inventor desires to grant to ASSIGNEE, the entire worldwide right, title, and interest in and to the INVENTION and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor (herein referred to ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to the ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the INVENTION, the APPLICATION, and any and all other patent applications and patents for the INVENTION which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, continuations-in-part, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the INVENTION, to ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned

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had this Assignment not been made; and each undersigned inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the INVENTION, the APPLICATION, and all related patents and applications, in ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by ASSIGNEE, its successors, legal representatives, and assigns.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

The undersigned hereby grant(s) the law firm of **Cantor Colburn LLP** the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.


Legal Name of Inventor: **Soonok JEON**

Signature:  Date: 2018.9.10

Legal Name of Inventor: **Hiroshi MIYAZAKI**

Signature:  Date: 2018.9.10


Legal Name of Inventor: **Yeonsook CHUNG**

Signature:  Date: 2018.9.10

Legal Name of Inventor: **Kyungdoc KIM**

Signature:  Date: 2018.9.10

Legal Name of Inventor: **Youngmin NAM**

Signature:  Date: 2018.9.10

Legal Name of Inventor: **Myungsun SIM**

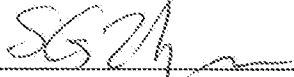
Signature:  Date: 2018.9.10

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Legal Name of Inventor: **Hasup LEE**

Signature:  Date: 2018.9.10

Legal Name of Inventor: **Sooghang IHN**

Signature:  Date: 2018.9.10

Legal Name of Inventor: **Yasushi KOISHIKAWA**

Signature:  Date: 2018.9.10